Orlando, Florida, March 14, 2004
http://ciae.cs.uiuc.edu/perware/

This workshop aims at bringing together researchers in the field of middleware for pervasive computing to discuss new trends for pervasive computing middleware.

Topics
The workshop solicits papers addressing the following topics:

- Middleware design patterns for pervasive computing.
- Middleware platforms for mobile devices.
- Middleware support for user-centric computing.
- Middleware support for novel pervasive computing application models.
- Adaptable, recoverable, secure and fault tolerant middleware for pervasive computing.

Submission Guidelines
In order to ensure a high quality technical session, submissions must cover one of the topics above, and should not exceed five pages. Furthermore, we will prioritize experience papers describing lessons learnt from built systems, including information about approaches that did and did not work, unexpected results, common abstractions, and metrics for evaluating pervasive computing middleware infrastructures.

Submissions of papers are solicited in the IEEE proceedings format. Research papers must be original prior unpublished work and not under review elsewhere. All submissions will be reviewed blindly and selected based on their originality, merit, and relevance to the workshop. Accepted papers must be presented at the workshop, and will appear in a combined PerCom ‘04 workshop proceedings.

Please visit http://ciae.cs.uiuc.edu/perware/ if you have any questions.

Important Dates
Paper Submission: October 1, 2003
Camera-Ready: December 10, 2003
Acceptance Notification: November 15, 2003
Workshop Date: March 14, 2004

Organizing Committee
Manuel Roman, DoCoMo Labs, USA
Roy Campbell, Univ. of Illinois at Urbana-Champaign
Christian Becker, Univ. of Stuttgart, Germany
Jalal Al-Muhtadi, Univ. of Illinois at Urbana-Champaign

Program Committee
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